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LOC	DIST	REVISIONS				
P	LTR	DESCRIPTION	DATE	DWN	APVD	
J	-	0	RELEASED	FJ00-1726-01	10SEP2001	D.M S.M
		A	ADD P/N	FJ00-1227-02	10MAY2002	D.M S.M
		AI	REVISED	FJ00-2030-02	27SEP2002	D.M S.M
		B	REVISED	FJ00-0125-03	24FEB04	K.R K.S

注記

- 材料:ハウジング:ガラス入り熱可塑性ポリエステル樹脂,94V-0,黒
コンタクト:銅合金
- メッキ:コンタクト:全面Ni下地 1.27μm MIN
接点部:0.2μm MIN 金メッキ
基板取付部:2μm MIN 錫メッキ

△3 -5(5POS)と-7(7POS)は、回路番号6と8にコンタクトが装着されません

NOTE

- MATERIAL:HOUSING:GLASS FILED THERMOPLASTIC,94V-0,BLACK
CONTACT:COPPER ALLOY
- FINISH:UNDERPLATE:Ni 1.27μm min.
CONTACT AREA:Au 0.2μm min.
P.C.BOARD ATTACHMENT AREA:Tin 2μm min.

△3 -5(5POS) AND -7(7POS) DO NOT EQUIP WITH CONTACT OF CIRCUIT NO 6 AND 8.

推奨基板寸法 (t=1.6±0.2)
RECOMMENDED PC BOARD HOLE PATTERN

△3 IN CASE OF 3POS.
△3 IN CASE OF 4~8POS.

△3	4	16.9	24	13.05	23.8	10.75	14	7	8	1473565-8
△3	6	16.9	24	13.05	23.8	10.75	12	7	7	1473565-7
	4	12.9	20	11.05	19.8	8.75	10	5	6	1473565-6
	6	12.9	20	11.05	19.8	8.75	8	5	5	1473565-5
	4	8.9	16	9.05	15.8	6.75	6	3	4	1473565-4
	4	6.9	14	8.05	13.8	5.75	4	2	3	1473565-3
	G	F	E	D	C	B	A	N	POS	P/N

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DIMENSIONS: mm		CHK S. MANABE	10SEP2001	NAME HDR-ASSY(IROW) FOR E-CON - RITS CONN. -	
TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± ±0.2 1 PLC ± ±0.2 2 PLC ± ±3° 3 PLC ± ±3° 4 PLC ± ± ANGLES ± ±		APVD S. MANABE	10SEP2001	DRAWING NO C=1473565	
MATERIAL -		PRODUCT SPEC 108-5765		SIZE A3	RESTRICTED TO -
FINISH -		APPLICATION SPEC -		CAGE CODE 00779	SCALE 4:1
		WEIGHT -		DRAWING NO C=1473565	SHEET 1 OF 1
				CUSTOMER DRAWING	REV B

AMP 1470-19 REV 31MAR2000

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